

L Number	Hits	Search Text	DB	Time stamp
2	159	313/\$.ccls. and corrugated	USPAT; EPO; JPO	2003/06/16 07:18
3	32	313/\$.ccls. and corrugated and substrate	USPAT; EPO; JPO	2003/06/16 07:24
1	907	313/506.ccls.	USPAT; EPO; JPO	2003/06/16 11:17
4	2498	corrugated and substrate and light	USPAT; EPO; JPO	2003/06/16 07:24
5	181	corrugated and substrate and "light emitting"	USPAT; EPO; JPO	2003/06/16 07:24
14	6	313/506.ccls. and (texture)	USPAT; EPO; JPO	2003/06/16 08:08
15	4	313/506.ccls. and (textured)	USPAT; EPO; JPO	2003/06/16 08:11
16	75	313/506.ccls. and (uneven)	USPAT; EPO; JPO	2003/06/16 08:11
23	256	257/95.ccls.	USPAT; EPO; JPO	2003/06/16 08:25
24	1301	257/98.ccls.	USPAT; EPO; JPO	2003/06/16 08:25
49	1114	(IWATA nearl HIROSHI).in.	USPAT; EPO; JPO	2003/06/16 10:32
50	272	(IWATA nearl HIROSHI).in. and semiconductor	USPAT; EPO; JPO	2003/06/16 10:32
51	716	313/504.ccls.	USPAT; EPO; JPO	2003/06/16 11:17
52	243	313/498.ccls.	USPAT; EPO; JPO	2003/06/16 11:17